# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

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# MCR25DG, MCR25MG, MCR25NG

# Silicon Controlled Rectifiers Reverse Blocking Thyristors

Designed primarily for half-wave ac control applications, such as motor controls, heating controls, and power supplies; or wherever half-wave, silicon gate-controlled devices are needed.

#### Features

- Blocking Voltage to 800 Volts
- On-State Current Rating of 25 Amperes RMS
- High Surge Current Capability 300 Amperes
- Rugged, Economical TO-220AB Package
- Glass Passivated Junctions for Reliability and Uniformity
- Minimum and Maximum Values of I<sub>GT</sub>, V<sub>GT</sub>, and I<sub>H</sub> Specified for Ease of Design
- High Immunity to dv/dt 100 V/µsec Minimum @ 125°C
- These are Pb–Free Devices

#### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

Bating Ormshal Malua Unit					
Rating	Symbol	Value	Unit		
$\begin{array}{l} \mbox{Peak Repetitive Off-State Voltage (Note 1)} \\ (T_J = -40 \mbox{ to } 125^{\circ}\mbox{C}, \mbox{ Sine Wave}, \\ 50 \mbox{ to } 60 \mbox{ Hz}, \mbox{ Gate Open}) & \mbox{MCR25DG} \\ & \mbox{MCR25MG} \\ & \mbox{MCR25NG} \end{array}$	V <sub>DRM,</sub> V <sub>RRM</sub>	400 600 800	V		
On-State RMS Current (180° Conduction Angles; T <sub>C</sub> = 80°C)	I <sub>T(RMS)</sub>	25	A		
Peak Non-repetitive Surge Current (1/2 Cycle, Sine Wave 60 Hz, $T_J = 125^{\circ}C$ )	I <sub>TSM</sub>	300	A		
Circuit Fusing Consideration (t = 8.3 ms)	l <sup>2</sup> t	373	A <sup>2</sup> sec		
Forward Peak Gate Power (Pulse Width $\leq 1.0~\mu s,~T_C$ = 80°C)	P <sub>GM</sub>	20.0	W		
Forward Average Gate Power (t = 8.3 ms, $T_C = 80^{\circ}C$ )	$P_{G(AV)}$	0.5	W		
Forward Peak Gate Current (Pulse Width $\leq$ 1.0 µs, T <sub>C</sub> = 80°C)	I <sub>GM</sub>	2.0	A		
Operating Junction Temperature Range	TJ	-40 to +125	°C		
Storage Temperature Range	T <sub>stg</sub>	-40 to +150	°C		

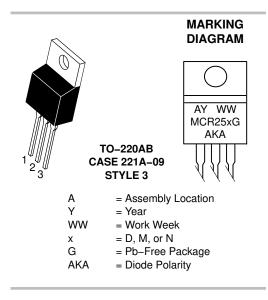
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

 V<sub>DRM</sub> and V<sub>RRM</sub> for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.



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PIN ASSIGNMENT		
1	Cathode	
2	Anode	
3	Gate	
4	Anode	

### ORDERING INFORMATION

Device	Package	Shipping
MCR25DG	TO-220AB (Pb-Free)	50 Units / Rail
MCR25MG	TO-220AB (Pb-Free)	50 Units / Rail
MCR25NG	TO-220AB (Pb-Free)	50 Units / Rail

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#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case Junction-to-Ambient	$R_{ heta JC} \ R_{ heta JA}$	1.5 62.5	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	TL	260	°C

#### **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Peak Repetitive Forward or Reverse Blocking Current ( $V_{AK}$ = Rated $V_{DRM}$ or $V_{RRM}$ , Gate Open)	T <sub>J</sub> = 25°C T <sub>J</sub> = 125°C	I <sub>DRM</sub> I <sub>RRM</sub>			0.01 2.0	mA
ON CHARACTERISTICS						
Peak Forward On-State Voltage (Note 2) (I <sub>TM</sub> = 50 A)		V <sub>TM</sub>	-	-	1.8	V
Gate Trigger Current (Continuous dc) $(V_D = 12 \text{ V}, \text{ R}_L = 100 \Omega)$		I <sub>GT</sub>	4.0	12	30	mA
Gate Trigger Voltage (Continuous dc) $(V_D = 12 \text{ V}, \text{ R}_L = 100 \Omega)$		V <sub>GT</sub>	0.5	0.67	1.0	V
Holding Current (V <sub>D</sub> =12 Vdc, Initiating Current = 200 mA, Gate Open)		Ι <sub>Η</sub>	5.0	13	40	mA
Latching Current ( $V_D = 12 V$ , $I_G = 30 mA$ )		١L	-	35	80	mA

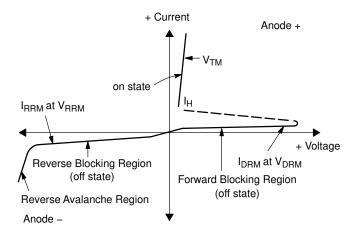
#### AIC CHARACTERISTICS

Critical Rate of Rise of Off–State Voltage $(V_D = 67\% \text{ of Rated } V_{DRM}, \text{ Exponential Waveform, Gate Open, } T_J = 125^{\circ}C)$	dv/dt	100	250	_	V/µs
Critical Rate of Rise of On–State Current (I <sub>PK</sub> = 50 A, Pw = 30 μsec, diG/dt = 1 A/μsec, Igt = 50 mA)	di/dt	-	-	50	A/μs

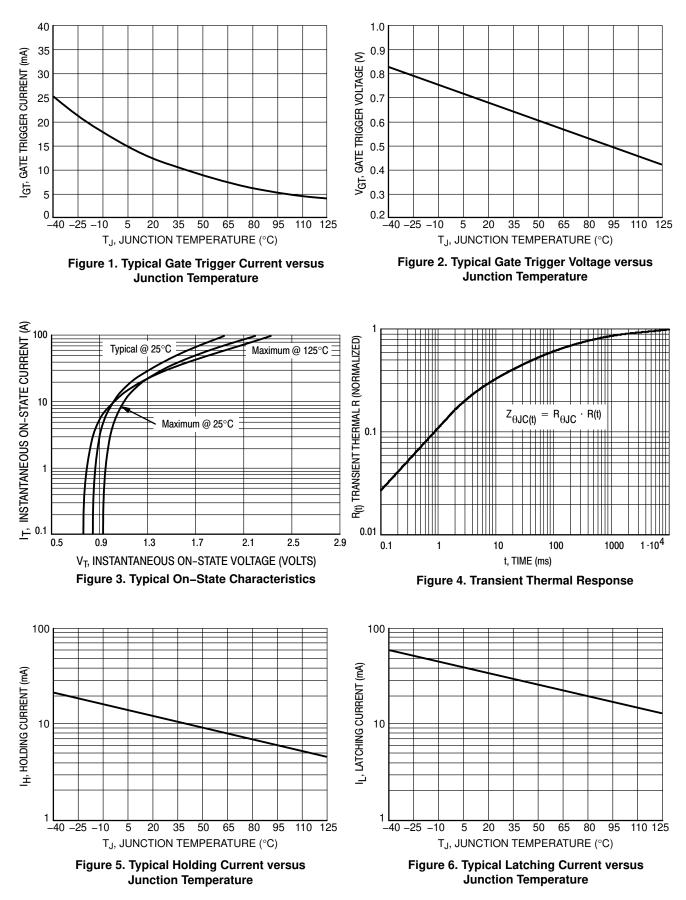
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Indicates Pulse Test: Pulse Width  $\leq$  2.0 ms, Duty Cycle  $\leq$  2%.

# Voltage Current Characteristic of SCR

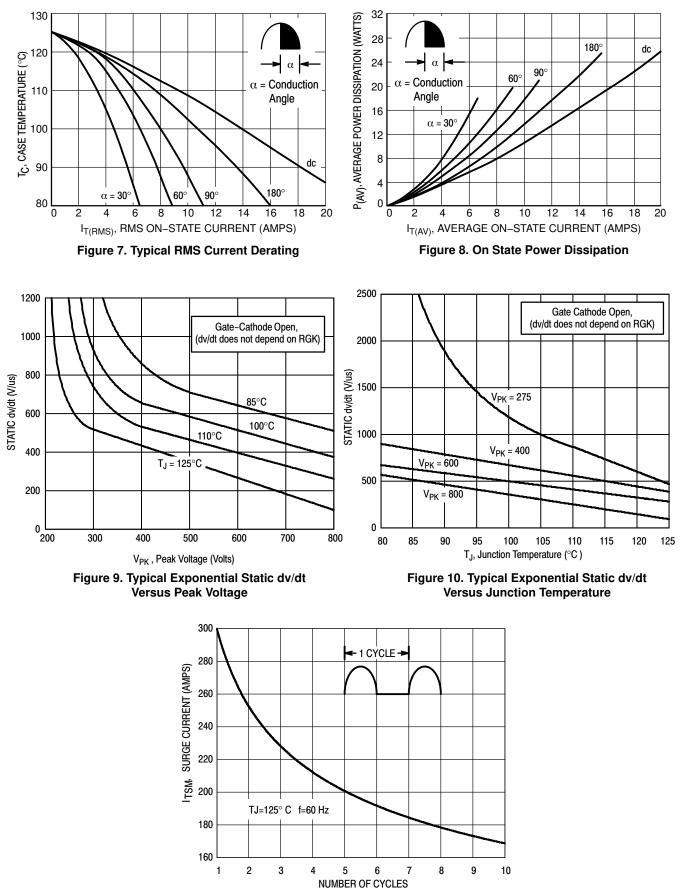
Symbol	Parameter
V <sub>DRM</sub>	Peak Repetitive Off State Forward Voltage
I <sub>DRM</sub>	Peak Forward Blocking Current
V <sub>RRM</sub>	Peak Repetitive Off State Reverse Voltage
I <sub>RRM</sub>	Peak Reverse Blocking Current
V <sub>TM</sub>	Peak On State Voltage
I <sub>H</sub>	Holding Current

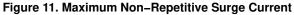


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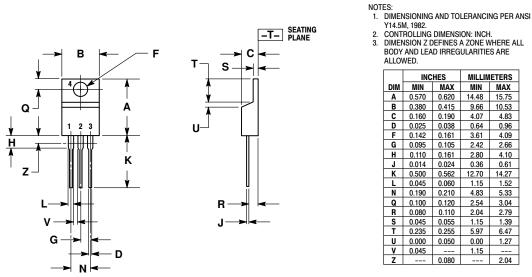
# MCR25DG, MCR25MG, MCR25NG





### PACKAGE DIMENSIONS

TO-220 CASE 221A-09 **ISSUE AH** 



DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED. INCHES MILLIMETERS DIM MIN MAX MIN MAX A 0.570 0.620 14.48 15.75 **B** 0.380 0.415 9.66 10.53 C 0.160 0.190 4.07 4.83 D 0.025 F 0.142 0.038 0.64 0.96 0.161 3.61 4.09 **G** 0.095 0.105 2.42 2.66 H 0.110 0.161 2.80 4.10 J 0.014 0.024 0.36 0.61 K 0.500 0.562 12.70 14.27 L 0.045 0.060 1.15 1.52 N 0.190 0.210 4.83 5.33 Q 0.100 0.120 2.54 3.04 R 0.080 2.04 0.110 2.79 S 0.045 T 0.235 0.055 1.15 1.39 0.255 5.97 6.47 **U** 0.000 0.050 0.00 1.27 V 0.045 1.15 z 0.080 2.04

STYLE 3: PIN 1. CATHODE 2. ANODE GATE 3. 4. ANODE

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